

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicants: T. HATTORI, et al.  
Serial No.: 10/576,494  
Filed: APRIL 20, 2006  
For: POSITIVE PHOTSENSITIVE RESIN COMPOSITION, METHOD  
FOR FORMING PATTERN, AND ELECTRONIC PART  
Group AU: 1752  
Examiner: John S. Y. Chu  
Confirm. No: 3727

**AMENDMENT**

**Mail Stop: AMEND – NO FEE**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

September 27, 2007

Sir:

In response to the Office Action dated June 28, 2007, please amend the above-identified application as listed below and as set forth on the following pages:

AMENDMENTS TO THE CLAIMS; and

REMARKS are included following the amendments.